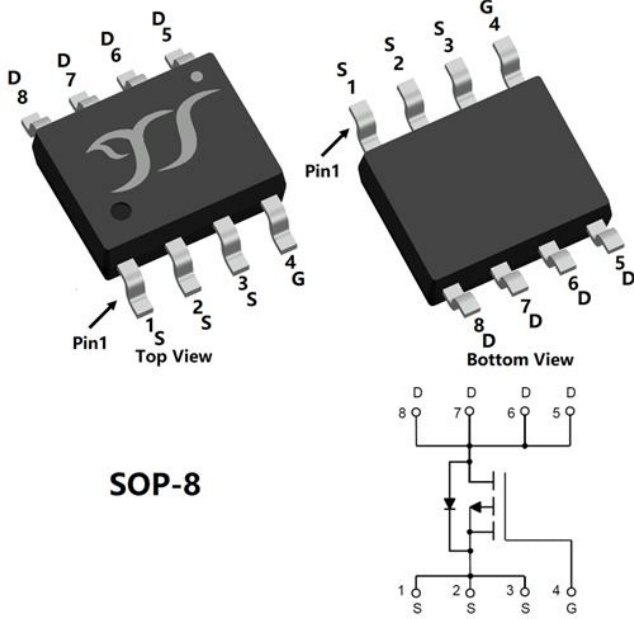


## P-Channel Enhancement Mode Field Effect Transistor



**SOP-8**

### Product Summary

|                                      |               |
|--------------------------------------|---------------|
| • $V_{DS}$                           | -60V          |
| • $I_D$                              | -3.5A         |
| • $R_{DS(ON)}$ ( at $V_{GS}=-10V$ )  | <72m $\Omega$ |
| • $R_{DS(ON)}$ ( at $V_{GS}=-4.5V$ ) | <94m $\Omega$ |
| • 100% EAS Tested                    |               |

### General Description

- High density cell design for Low  $R_{DS(ON)}$
- High Speed switching
- Moisture Sensitivity Level 1
- Epoxy Meets UL 94 V-0 Flammability Rating
- Halogen Free

### Applications

- PWM applications
- Power management
- Load switch

### Limiting Values

| Parameter                              | Conditions                                                       | Symbol         | Min | Max  | Unit        |
|----------------------------------------|------------------------------------------------------------------|----------------|-----|------|-------------|
| Drain-source Voltage                   |                                                                  | $V_{DS}$       | -   | -60  | V           |
| Gate-source Voltage                    |                                                                  | $V_{GS}$       | -20 | 20   |             |
| Continuous Drain Current (Note 1,2)    | Steady-State                                                     | $I_D$          | -   | -3.5 | A           |
|                                        | $T_A=25^{\circ}C, V_{GS}=-10V$                                   |                | -   | -2.2 |             |
|                                        | $T_A=100^{\circ}C, V_{GS}=-10V$                                  |                | -   | -2.2 |             |
| Pulsed Drain Current                   | $T_A=25^{\circ}C, t_p \leq 10\mu s$                              | $I_{DM}$       | -   | -28  |             |
| Maximum Body-Diode Continuous Current  | $T_A=25^{\circ}C$                                                | $I_S$          | -   | -1.9 |             |
| Avalanche energy (non-repetitive )     | $T_J=25^{\circ}C, V_G=-10V, R_G=25\Omega, L=0.5mH, I_{AS}=-9.8A$ | EAS            | -   | 24   | mJ          |
| Total Power Dissipation (Note 1,2)     | Steady-State                                                     | $P_D$          | -   | 1.73 | W           |
|                                        | $T_A=100^{\circ}C$                                               |                | -   | 0.69 |             |
| Junction and Storage Temperature Range |                                                                  | $T_J, T_{STG}$ | -55 | 150  | $^{\circ}C$ |

### Thermal Resistance

| Parameter                                       | Symbol          | Typ | Max | Units         |
|-------------------------------------------------|-----------------|-----|-----|---------------|
| Thermal Resistance Junction-to-Ambient (Note 2) | $R_{\theta JA}$ | -   | 72  | $^{\circ}C/W$ |

### Ordering Information (Example)

| PREFERRED P/N | PACKING CODE | Marking | MINIMUM PACKAGE(pcs) | INNER BOX QUANTITY(pcs) | OUTER CARTON QUANTITY(pcs) | DELIVERY MODE |
|---------------|--------------|---------|----------------------|-------------------------|----------------------------|---------------|
| YJS072P06A    | F2           | 072P06A | 4000                 | 8000                    | 64000                      | 13" reel      |



## ■ Electrical Characteristics

| Parameter                         | Symbol              | Conditions                                                                                                      | Min | Typ   | Max  | Units |
|-----------------------------------|---------------------|-----------------------------------------------------------------------------------------------------------------|-----|-------|------|-------|
| Static Parameter                  |                     |                                                                                                                 |     |       |      |       |
| Drain-Source Breakdown Voltage    | BV <sub>DSS</sub>   | V <sub>GS</sub> =0V, I <sub>D</sub> =-250μA, T <sub>j</sub> =25°C                                               | -60 | -     | -    | V     |
| Zero Gate Voltage Drain Current   | I <sub>DSS</sub>    | V <sub>DS</sub> =-60V, V <sub>GS</sub> =0V, T <sub>j</sub> =25°C                                                | -   | -     | -1   | μA    |
|                                   |                     | V <sub>DS</sub> =-60V, V <sub>GS</sub> =0V, T <sub>j</sub> =150°C                                               | -   | -     | -100 |       |
| Gate-Source Leakage Current       | I <sub>GSS</sub>    | V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V, T <sub>j</sub> =25°C                                                | -   | -     | ±100 | nA    |
| Gate Threshold Voltage            | V <sub>GS(th)</sub> | V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =-250μA, T <sub>j</sub> =25°C                                 | -1  | -1.5  | -2   | V     |
| Static Drain-Source On-Resistance | R <sub>DS(ON)</sub> | V <sub>GS</sub> =-10V, I <sub>D</sub> =-2.7A, T <sub>j</sub> =25°C                                              | -   | 53    | 72   | mΩ    |
|                                   |                     | V <sub>GS</sub> =-4.5V, I <sub>D</sub> =-1.4A, T <sub>j</sub> =25°C                                             | -   | 63    | 94   | mΩ    |
| Diode Forward Voltage             | V <sub>SD</sub>     | I <sub>S</sub> =-2.7A, V <sub>GS</sub> =0V, T <sub>j</sub> =25°C                                                | -   | -0.81 | -1.2 | V     |
| Gate Resistance                   | R <sub>G</sub>      | f=1MHz, T <sub>j</sub> =25°C                                                                                    | -   | 5.1   | -    | Ω     |
| Dynamic Parameters                |                     |                                                                                                                 |     |       |      |       |
| Input Capacitance                 | C <sub>iss</sub>    | V <sub>DS</sub> =-30V, V <sub>GS</sub> =0V, f=1MHz, T <sub>j</sub> =25°C                                        | -   | 1175  | -    | pF    |
| Output Capacitance                | C <sub>oss</sub>    |                                                                                                                 | -   | 63    | -    |       |
| Reverse Transfer Capacitance      | C <sub>rss</sub>    |                                                                                                                 | -   | 55    | -    |       |
| Switching Parameters              |                     |                                                                                                                 |     |       |      |       |
| Total Gate Charge                 | Q <sub>g</sub>      | V <sub>GS</sub> =-10V, V <sub>DS</sub> =-30V, I <sub>D</sub> =-2.7A, T <sub>j</sub> =25°C                       | -   | 25    | -    | nC    |
| Gate-Source Charge                | Q <sub>gs</sub>     |                                                                                                                 | -   | 2.8   | -    |       |
| Gate-Drain Charge                 | Q <sub>gd</sub>     |                                                                                                                 | -   | 3.9   | -    |       |
| Reverse Recovery Charge           | Q <sub>rr</sub>     | I <sub>F</sub> =-2.7A, di/dt=100A/μs, V <sub>GS</sub> =0V, V <sub>R</sub> =-30V, T <sub>j</sub> =25°C           | -   | 21    | -    | nC    |
| Reverse Recovery Time             | t <sub>rr</sub>     |                                                                                                                 | -   | 20    | -    | ns    |
| Turn-on Delay Time                | t <sub>D(on)</sub>  | V <sub>GS</sub> =-10V, V <sub>DS</sub> =-30V, I <sub>D</sub> =-2.7A, R <sub>GEN</sub> =3Ω, T <sub>j</sub> =25°C | -   | 7.6   | -    | ns    |
| Turn-on Rise Time                 | t <sub>r</sub>      |                                                                                                                 | -   | 3.4   | -    |       |
| Turn-off Delay Time               | t <sub>D(off)</sub> |                                                                                                                 | -   | 38.5  | -    |       |
| Turn-off Fall Time                | t <sub>f</sub>      |                                                                                                                 | -   | 12.3  | -    |       |

Note:

- The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.
- The value of  $R_{\theta JA}$  is measured with the device mounted on the 80mm\*80mm\*1.1mm single layer FR-4 PCB board with 1 in<sup>2</sup> pad of 2oz. Copper, in the still air environment with  $T_A=25^\circ C$ . The maximum allowed junction temperature of  $150^\circ C$ . The value in any given application depends on the user's specific board design.

## ■ Typical Electrical and Thermal Characteristics Diagrams

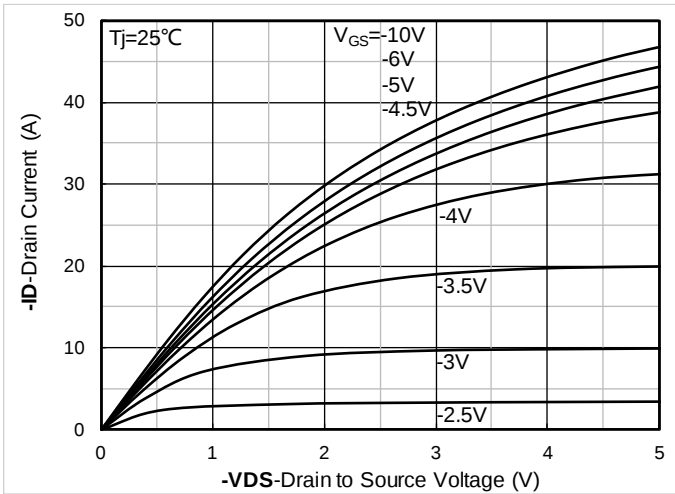


Figure 1. Output Characteristics; typical values

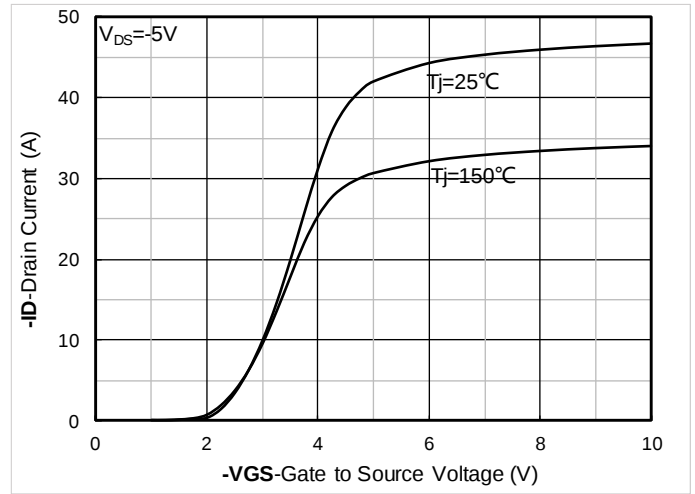


Figure 2. Transfer Characteristics; typical values

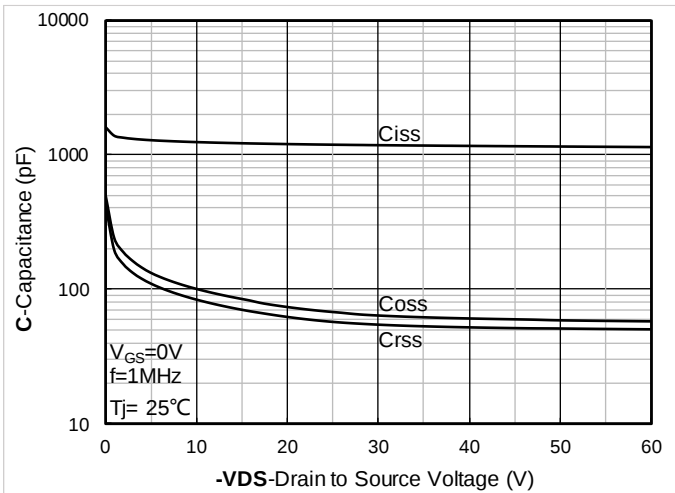


Figure 3. Capacitance Characteristics; typical values

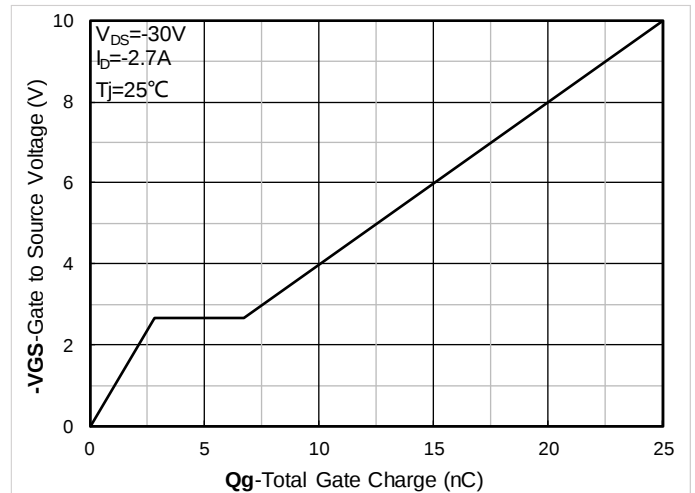


Figure 4. Gate Charge; typical values

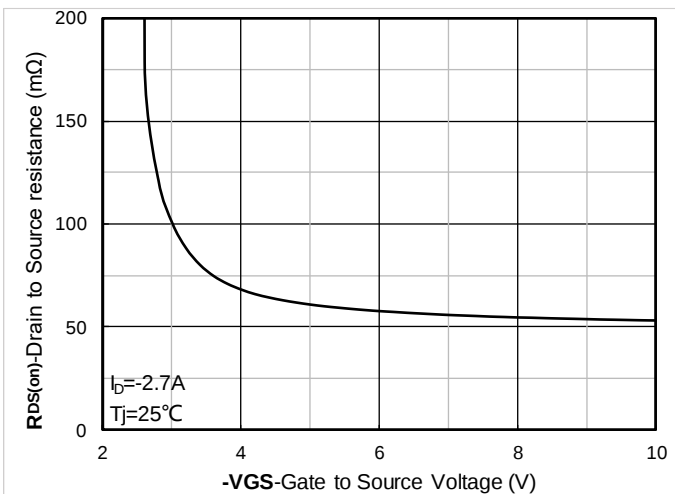


Figure 5. On-Resistance vs. Gate to Source Voltage; typical values

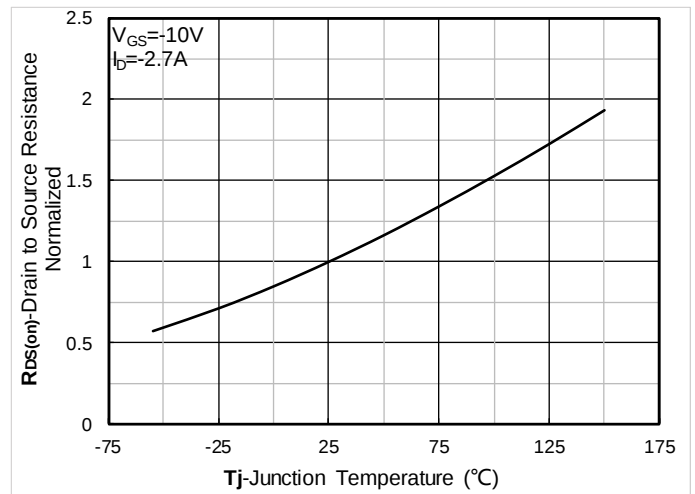


Figure 6. Normalized On-Resistance

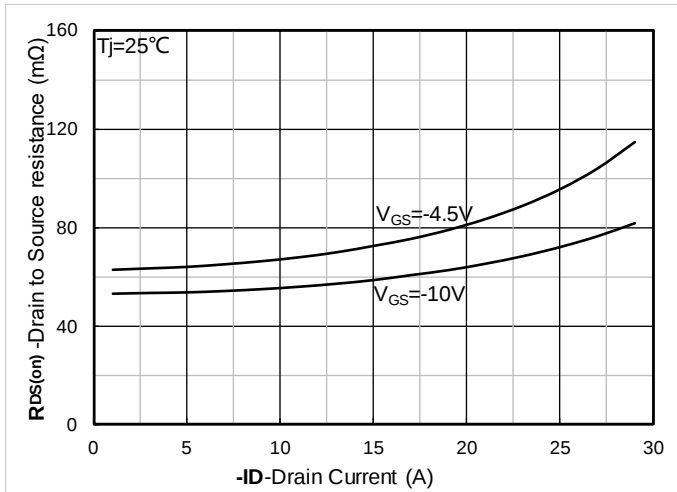


Figure 7.  $R_{DS(on)}$  vs. Drain Current; typical values

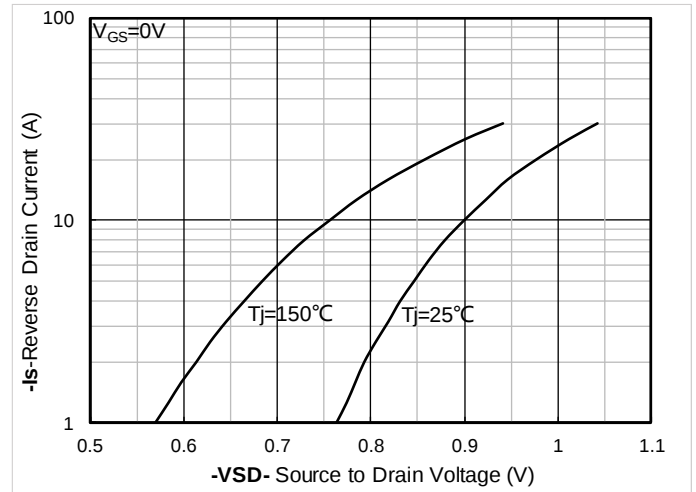


Figure 8. Forward characteristics of reverse diode; typical values

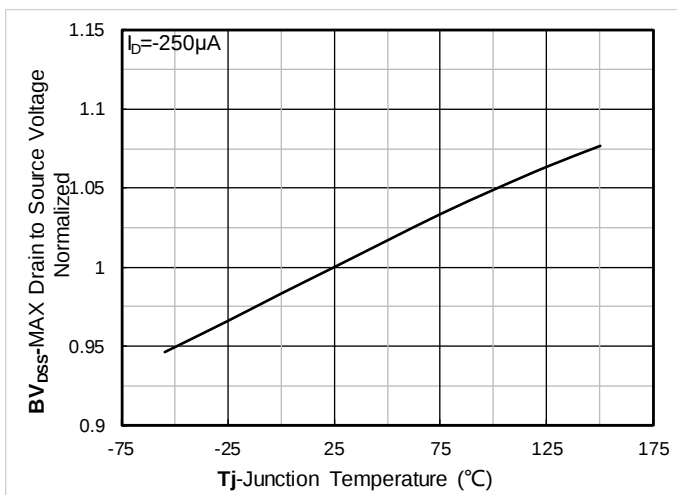


Figure 9. Normalized breakdown voltage

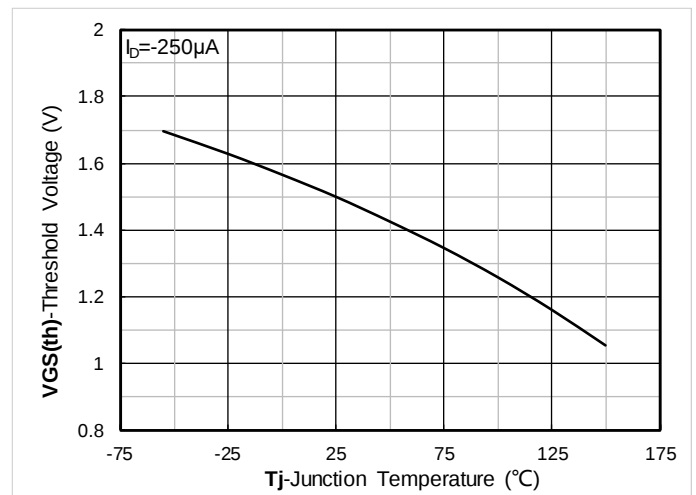


Figure 10. Gate Threshold voltage; typical values

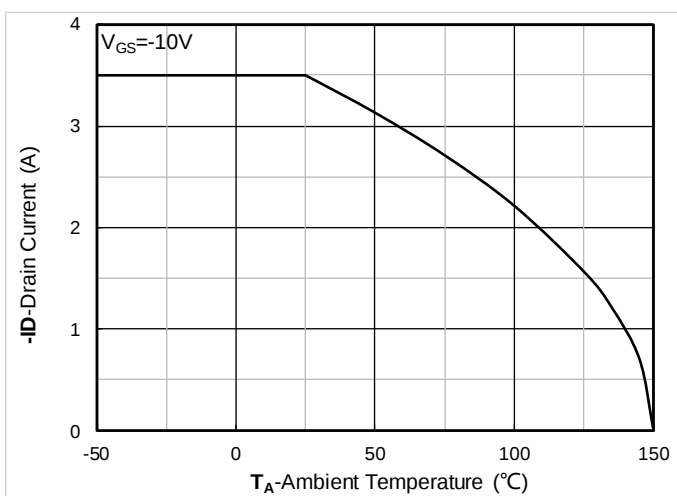


Figure 11. Current dissipation

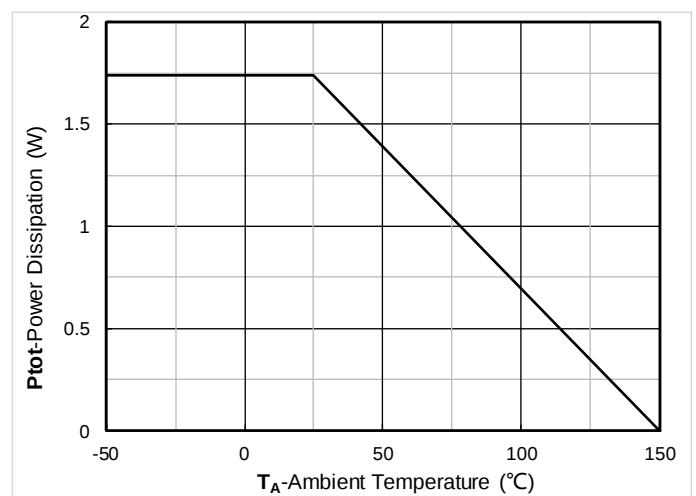


Figure 12. Power dissipation

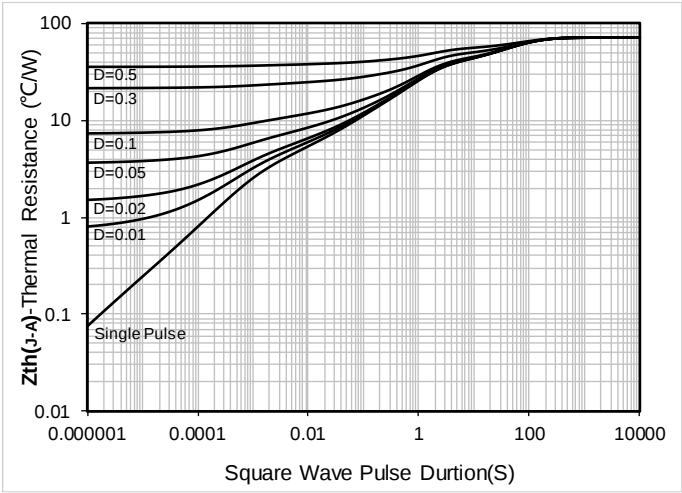


Figure 13. Maximum Transient Thermal Impedance

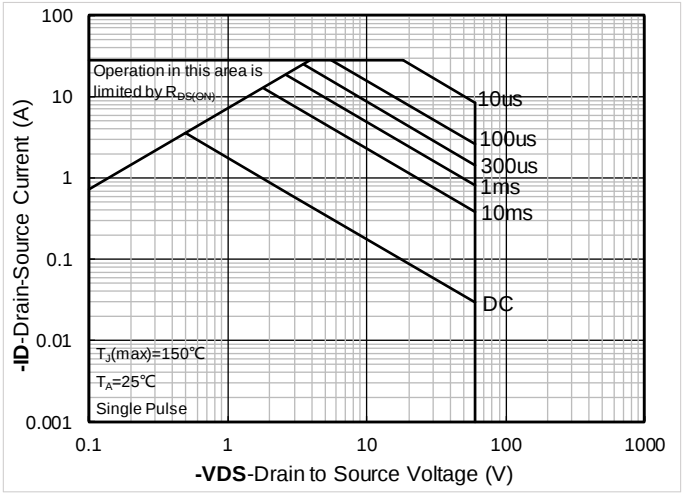
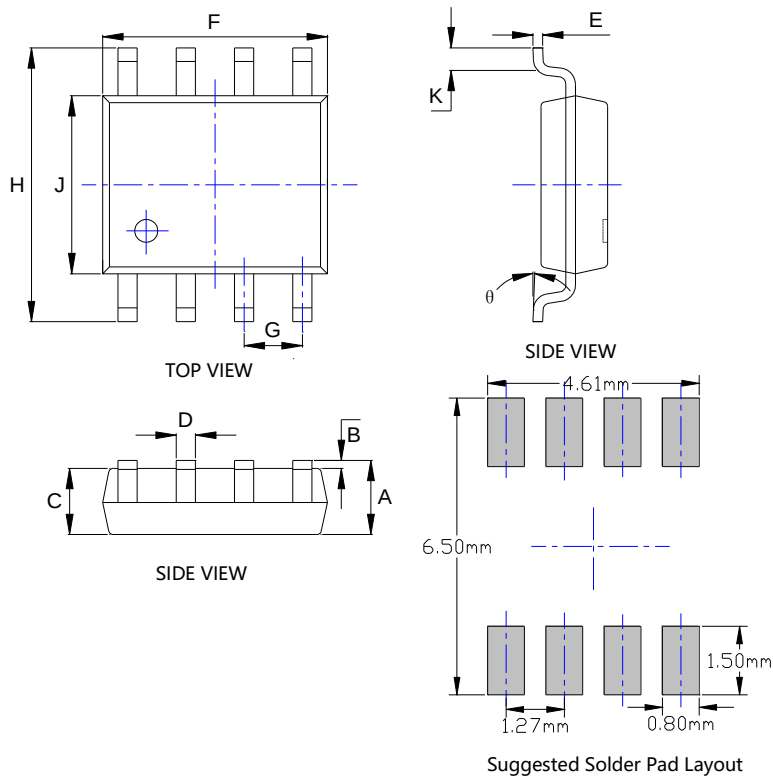


Figure 14. Safe Operation Area



## ■ SOP-8 Package information

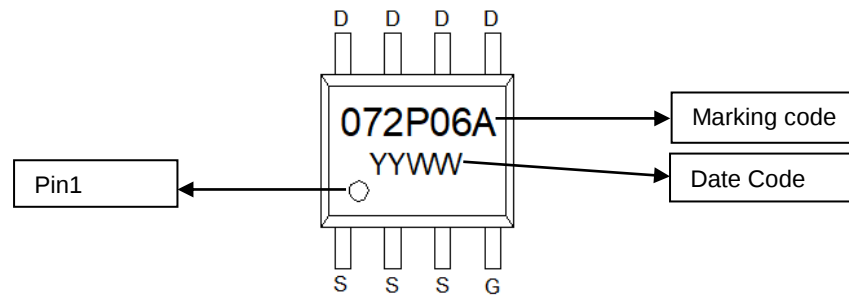


| SYMBOL | DIMENSIONS |       |            |       |
|--------|------------|-------|------------|-------|
|        | INCHES     |       | Millimeter |       |
|        | MIN.       | MAX.  | MIN.       | MAX.  |
| A      | 0.053      | 0.069 | 1.350      | 1.750 |
| B      | 0.004      | 0.010 | 0.100      | 0.250 |
| C      | 0.053      | 0.061 | 1.350      | 1.550 |
| D      | 0.013      | 0.020 | 0.330      | 0.510 |
| E      | 0.007      | 0.010 | 0.170      | 0.250 |
| F      | 0.189      | 0.197 | 4.800      | 5.000 |
| G      | 0.050BSC   |       | 1.270BSC   |       |
| H      | 0.228      | 0.244 | 5.800      | 6.200 |
| J      | 0.150      | 0.157 | 3.800      | 4.000 |
| K      | 0.016      | 0.050 | 0.400      | 1.270 |
| θ      | 0°         | 8°    | 0°         | 8°    |

### Note:

1. Controlling dimension: in millimeters.
2. General tolerance:  $\pm 0.05\text{mm}$ .
3. The pad layout is for reference purposes only.

## ■ Marking Information



Note:

1. All marking is at middle of the product body
2. All marking is in laser printing
3. 072P06A is marking code, YYWW is date code, "YY" is year, "WW" is week
4. Body color: Black



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